

MJB5742T4G Datasheet

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DiGi Electronics Part Number	MJB5742T4G-DG
Manufacturer	onsemi
Manufacturer Product Number	MJB5742T4G
Description	TRANS NPN DARL 400V 8A D2PAK
Detailed Description	Bipolar (BJT) Transistor NPN - Darlington 400 V 8 A 100 W Surface Mount D2PAK



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Purchase and inquiry

Manufacturer Product Number:

MJB5742T4G

Series:

-

Transistor Type:

NPN - Darlington

Voltage - Collector Emitter Breakdown (Max):

400 V

Current - Collector Cutoff (Max):

-

Power - Max:

100 W

Operating Temperature:

-65°C ~ 150°C (TJ)

Package / Case:

TO-263-3, D2PAK (2 Leads + Tab), TO-263AB

Base Product Number:

MJB5742

Manufacturer:

onsemi

Product Status:

Active

Current - Collector (Ic) (Max):

8 A

Vce Saturation (Max) @ Ib, Ic:

3V @ 400mA, 8A

DC Current Gain (hFE) (Min) @ Ic, Vce:

200 @ 4A, 5V

Frequency - Transition:

-

Mounting Type:

Surface Mount

Supplier Device Package:

D2PAK

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99

NPN Silicon Power Darlington Transistors

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The Darlington transistors are designed for high-voltage power switching in inductive circuits.

Features

- These Devices are Pb-Free and are RoHS Compliant

Applications

- Small Engine Ignition
- Switching Regulators
- Inverters
- Solenoid and Relay Drivers
- Motor Controls

MAXIMUM RATINGS

Symbol	Rating	Value	Unit
$V_{CEO(sus)}$	Collector-Emitter Voltage	400	Vdc
V_{CEV}	Collector-Emitter Voltage	800	Vdc
V_{EB}	Emitter-Base Voltage	8	Vdc
I_C I_{CM}	Collector Current – Continuous – Peak (Note 1)	8 16	Adc
I_B I_{BM}	Base Current – Continuous – Peak (Note 1)	2.5 5	Adc
P_D	Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	2 0.016	W W/ $^\circ\text{C}$
P_D	Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	100 0.8	W W/ $^\circ\text{C}$
T_J, T_{stg}	Operating and Storage Junction Temperature Range	-65 to +150	$^\circ\text{C}$

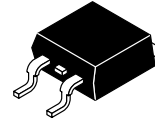
THERMAL CHARACTERISTICS

Symbol	Characteristics	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.25	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	$^\circ\text{C}/\text{W}$
T_L	Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 5 Seconds	275	$^\circ\text{C}$

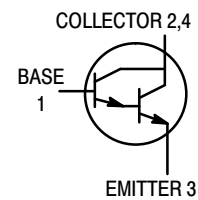
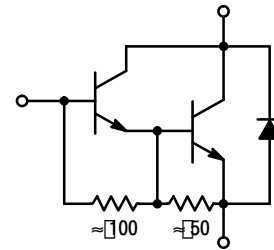
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Pulse Test: Pulse Width = 5 ms, Duty Cycle \leq 10%.

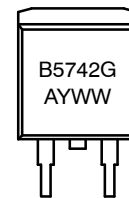
POWER DARLINGTON TRANSISTORS 8 AMPERES, 400 VOLTS 100 WATTS



D²PAK
CASE 418B
STYLE 1



MARKING DIAGRAM



B5742 = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
MJB5742T4G	D ² PAK (Pb-Free)	800 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, [BRD8011/D](#).

MJB5742T4G**ELECTRICAL CHARACTERISTICS** ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Characteristic	Min	Typ	Max	Unit
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OFF CHARACTERISTICS (Note 2)

$V_{CEO(sus)}$	Collector–Emitter Sustaining Voltage ($I_C = 50\text{ mA}$, $I_B = 0$)	400	–	–	Vdc
I_{CEV}	Collector Cutoff Current ($V_{CEV} = \text{Rated Value}$, $V_{BE(off)} = 1.5\text{ Vdc}$) ($V_{CEV} = \text{Rated Value}$, $V_{BE(off)} = 1.5\text{ Vdc}$, $T_C = 100^\circ\text{C}$)	–	–	1 5	mAdc
I_{EBO}	Emitter Cutoff Current ($V_{EB} = 8\text{ Vdc}$, $I_C = 0$)	–	–	75	mAdc

SECOND BREAKDOWN

$I_{S/b}$	Second Breakdown Collector Current with Base Forward Biased	See Figure 6			
RBSOA	Clamped Inductive SOA with Base Reverse Biased	See Figure 7			

ON CHARACTERISTICS (Note 2)

h_{FE}	DC Current Gain ($I_C = 0.5\text{ Adc}$, $V_{CE} = 5\text{ Vdc}$) ($I_C = 4\text{ Adc}$, $V_{CE} = 5\text{ Vdc}$)	50 200	100 400	– –	–
$V_{CE(sat)}$	Collector–Emitter Saturation Voltage ($I_C = 4\text{ Adc}$, $I_B = 0.2\text{ Adc}$) ($I_C = 8\text{ Adc}$, $I_B = 0.4\text{ Adc}$) ($I_C = 4\text{ Adc}$, $I_B = 0.2\text{ Adc}$, $T_C = 100^\circ\text{C}$)	– – –	– – –	2 3 2.2	Vdc
$V_{BE(sat)}$	Base–Emitter Saturation Voltage ($I_C = 4\text{ Adc}$, $I_B = 0.2\text{ Adc}$) ($I_C = 8\text{ Adc}$, $I_B = 0.4\text{ Adc}$) ($I_C = 4\text{ Adc}$, $I_B = 0.2\text{ Adc}$, $T_C = 100^\circ\text{C}$)	– – –	– – –	2.5 3.5 2.4	Vdc
V_f	Diode Forward Voltage (Note 3) ($I_F = 5\text{ Adc}$)	–	–	2.5	Vdc

SWITCHING CHARACTERISTICS

Typical Resistive Load (Table 1)						
t_d	Delay Time	$(V_{CC} = 250\text{ Vdc}$, $I_{C(pk)} = 6\text{ A}$ $I_{B1} = I_{B2} = 0.25\text{ A}$, $t_p = 25\text{ }\mu\text{s}$, Duty Cycle $\leq 1\%$)	–	0.04	–	μs
t_r	Rise Time		–	0.5	–	μs
t_s	Storage Time		–	8	–	μs
t_f	Fall Time		–	2	–	μs
Inductive Load, Clamped (Table 1)						
t_{sv}	Voltage Storage Time	$(I_{C(pk)} = 6\text{ A}$, $V_{CE(pk)} = 250\text{ Vdc}$ $I_{B1} = 0.06\text{ A}$, $V_{BE(off)} = 5\text{ Vdc}$)	–	4	–	μs
t_c	Crossover Time		–	2	–	μs

2. Pulse Test: Pulse Width 300 μs , Duty Cycle = 2%.

3. The internal Collector–to–Emitter diode can eliminate the need for an external diode to clamp inductive loads. Tests have shown that the Forward Recovery Voltage (V_f) of this diode is comparable to that of typical fast recovery rectifiers.

MJB5742T4G

TYPICAL CHARACTERISTICS

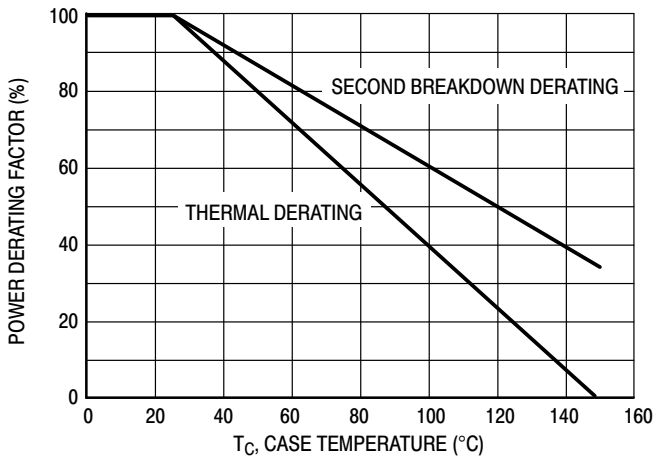


Figure 1. Power Derating

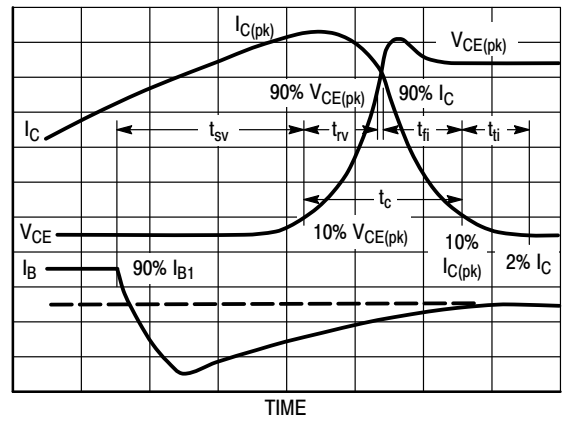


Figure 2. Inductive Switching Measurements

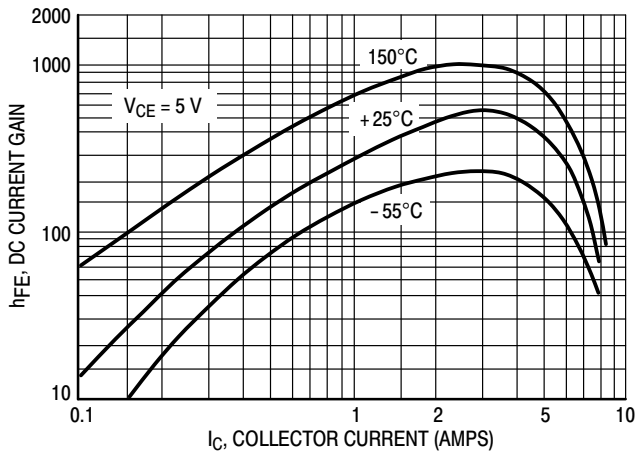


Figure 3. DC Current Gain

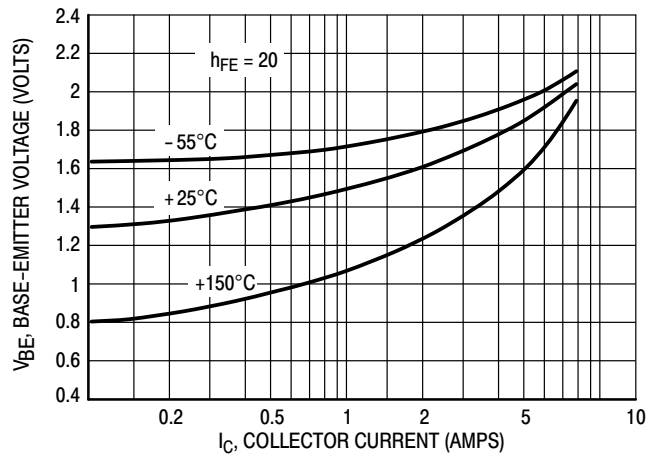


Figure 4. Base-Emitter Voltage

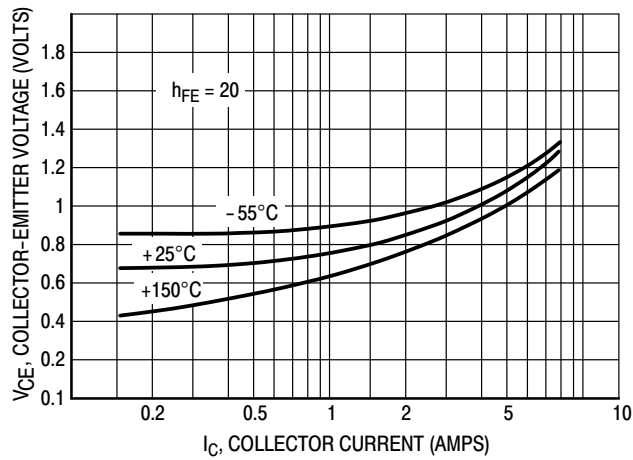


Figure 5. Collector-Emitter Saturation Voltage

MJB5742T4G

SAFE OPERATING AREA INFORMATION

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 6 is based on $T_C = 25^\circ\text{C}$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \geq 25^\circ\text{C}$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 6 may be found at any case temperature by using the appropriate curve on Figure 1.

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current condition allowable during reverse biased turnoff. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 7 gives the complete RBSOA characteristics.

The Safe Operating Area figures shown in Figures 6 and 7 are specified ratings for these devices under the test conditions shown.

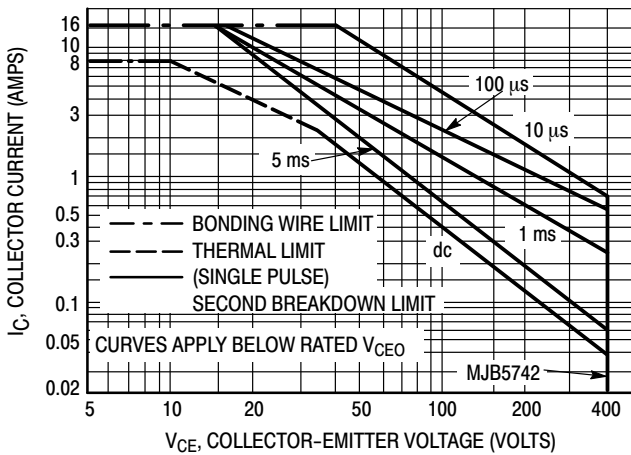


Figure 6. Forward Bias Safe Operating Area

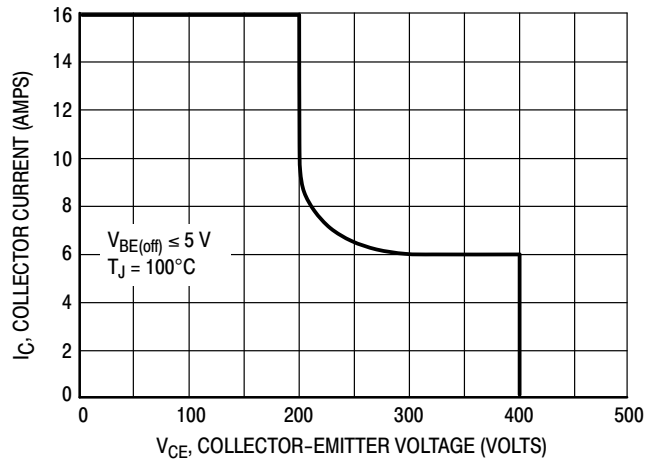


Figure 7. Reverse Bias Safe Operating Area

RESISTIVE SWITCHING PERFORMANCE

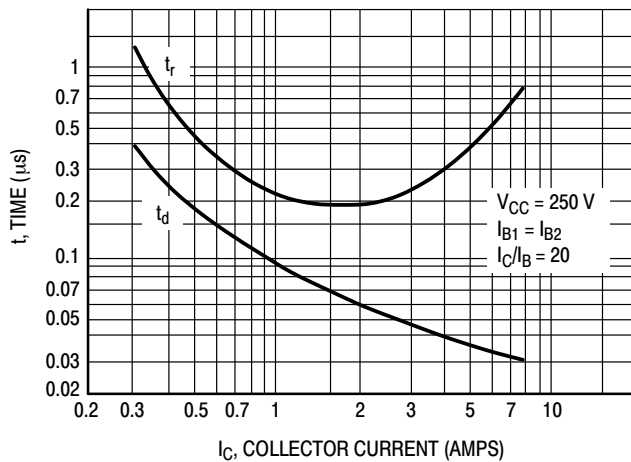


Figure 8. Turn-On Time

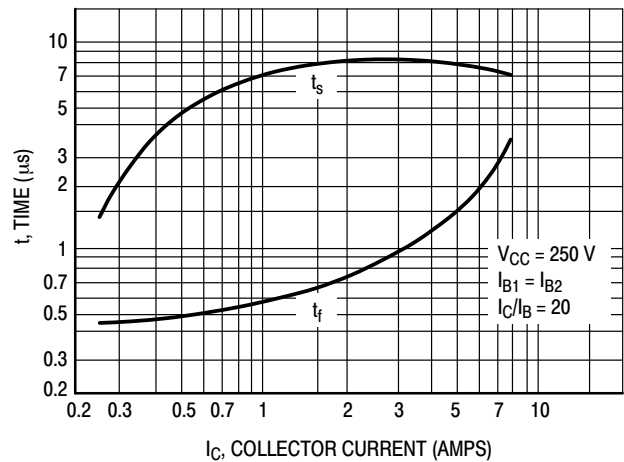
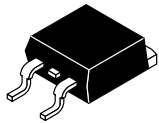


Figure 9. Turn-Off Time



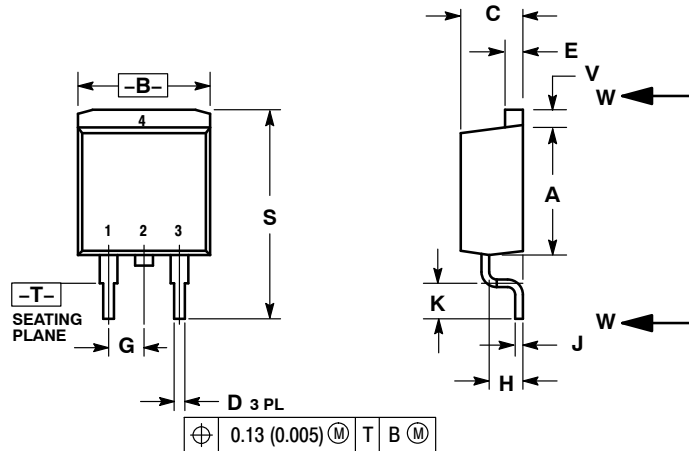
**MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS**



D²PAK 3
CASE 418B-04
ISSUE L

DATE 17 FEB 2015

SCALE 1:1

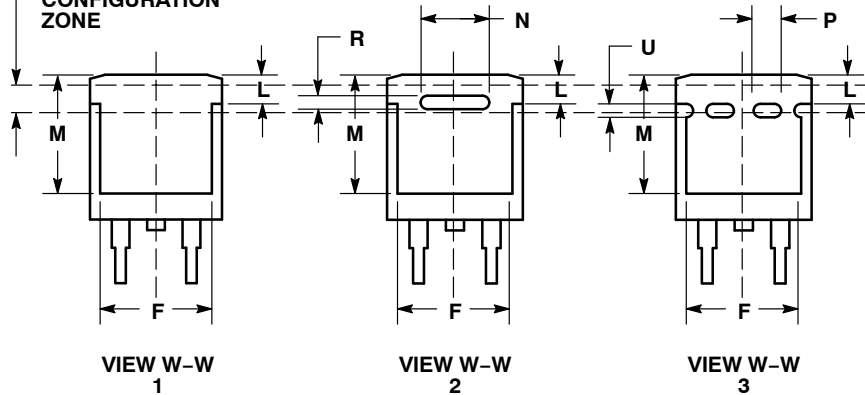


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.340	0.380	8.64	9.65
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
F	0.310	0.350	7.87	8.89
G	0.100	BSC	2.54	BSC
H	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
L	0.052	0.072	1.32	1.83
M	0.280	0.320	7.11	8.13
N	0.197	REF	5.00	REF
P	0.079	REF	2.00	REF
R	0.039	REF	0.99	REF
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40

VARIABLE CONFIGURATION ZONE



- | | | | | | |
|--|---|---|--|---|--|
| STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR | STYLE 2:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN | STYLE 3:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. CATHODE | STYLE 4:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR | STYLE 5:
PIN 1. CATHODE
2. ANODE
3. CATHODE
4. ANODE | STYLE 6:
PIN 1. NO CONNECT
2. CATHODE
3. ANODE
4. CATHODE |
|--|---|---|--|---|--|

MARKING INFORMATION AND FOOTPRINT ON PAGE 2

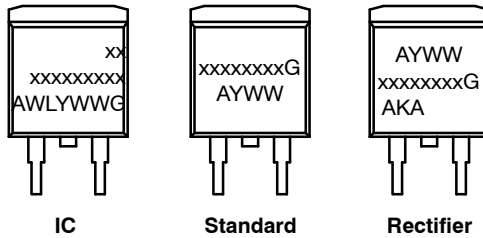
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D²PAK 3
CASE 418B-04
ISSUE L

DATE 17 FEB 2015

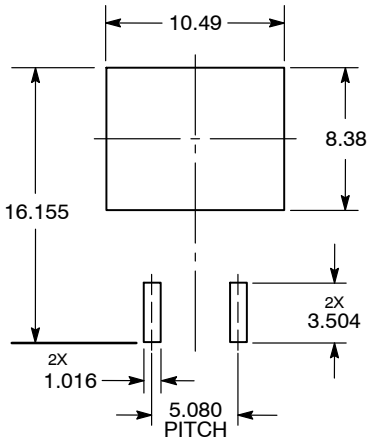
GENERIC MARKING DIAGRAM*



- xx = Specific Device Code
- A = Assembly Location
- WL = Wafer Lot
- Y = Year
- WW = Work Week
- G = Pb-Free Package
- AKA = Polarity Indicator

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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